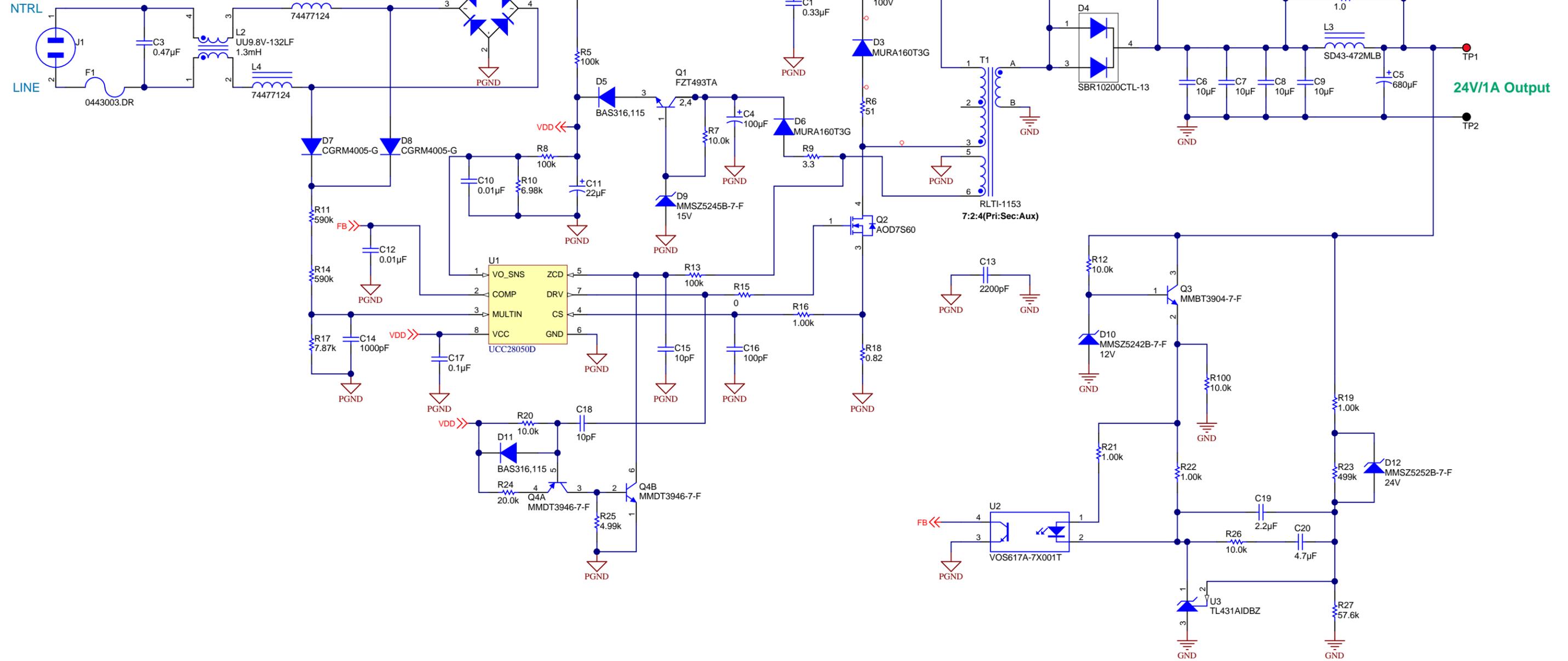


**Assembly Notes:**

1. Built on PMP11155 Rev B PCB.
2. R100 was added for Rev C.
3. C2 and R9 do not match land pattern on PCB.
4. Q4 and T1 pinouts are incorrect on PCB.



90VAC-264VAC Input



PCB Number: PMP11155  
PCB Rev: B

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Orderable: N/A	Designed for:	Mod. Date: 5/14/2017
TID #:	Project Title: Universal AC Input, 24V/1A PFC-Flyback	
Number: PMP11155	Rev: C	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: PMP11155_REV.C_SchDoc	Size: B
Engineer: B King	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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